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FCA16N60 / FCA16N60_F109

600V N-Channel MOSFET

Features

- 650V @T_J = 150°C
- Typ. Rds(on)=0.22Ω
- Ultra low gate charge (typ. Qg=55nC)
- Low effective output capacitance (typ. Coss.eff=110pF)
- 100% avalanche tested
- RoHS Compliant



Description

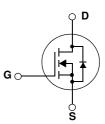
SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

December 2008

SuperFET

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





Absolute Maximum Ratings

Symbol	Parameter		FCA16N60	Unit
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous (T - Continuous (T		16 10.1	A A
I _{DM}	Drain Current - Pulsed	(Note 1)	48	A
V _{GSS}	Gate-Source voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	450	mJ
I _{AR}	Avalanche Current (Note 1) 16		16	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	16.7	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C		167 1.33	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature F	Range	-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCA16N60	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	0.75	°C/W	
R _{0JA} Thermal Resistance, Junction-to-Ambient		41.7	°C/W	

FCA16N60 / I
/ FCA16N60_
_F109
600V
N-Channel MOSFE
NOSFET

Device Marking Device Pa		Pac	kage Reel Size Tape		e Width		Quantity			
FCA16	N60	-)-3P -		-		30		
FCA16	N60	FCA16N60_F109	TO	-3PN	-		-		30	
Electric	al Cha	racteristics T _c	; = 25°C unles	s otherwise no	oted					
Symbol				Conditions		Min	Тур	Max	Units	
Off Charac	teristics			Į		Į			ļ	Į
BV _{DSS}	Drain-Sou	urce Breakdown Volta	ge	$V_{GS} = 0V,$	I _D = 250μA, T _J = 25°C		600			V
				$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}C$			650		V	
ΔΒV _{DSS} / ΔΤ _J			re	$I_D = 250\mu$ A, Referenced to 25°C			0.6		V/°C	
BV _{DS}	Drain-Source Avalanche Breakdown Voltage		V _{GS} = 0V, I _D = 16A			700		V		
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$				1 10	μΑ μΑ		
IGSSF	Gate-Boo	-Body Leakage Current, Forward		$V_{\rm DS} = 30V, V_{\rm DS} = 0V$					100	nA
I _{GSSR}	Gate-Bod	te-Body Leakage Current, Reverse		$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Charac				0.0	50					
V _{GS(th)}	Gate Threshold Voltage		$V_{DS} = V_{GS}$	_S , I _D = 250μA		3.0		5.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 10\	-			0.22	0.26	Ω	
9 _{FS}	Forward ⁻	Transconductance		V _{DS} = 40\	/, I _D = 8A (Note 4)		11.5		S
Dynamic C	haracteris	stics								
C _{iss}	Input Cap	ut Capacitance $V_{DS} = 25V, V_{GS} = 0V,$ put Capacitancef = 1.0MHz		/, V _{GS} = 0V,			1730	2250	pF	
C _{oss}	Output Ca			f = 1.0MHz			960	1150	pF	
C _{rss}	Reverse ⁻	Transfer Capacitance					85		pF	
C _{oss}	Output Capacitance		$V_{DS} = 480$	$V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz$			45	60	pF	
C _{oss} eff.	Effective Output Capacitance			V_{DS} = 0V to 400V, V_{GS} = 0V				110		pF
Switching	Character	istics								
t _{d(on)}	Turn-On I	Delay Time		$V_{DD} = 300V, I_D = 16A$ $R_G = 25\Omega$				42	85	ns
t _r	Turn-On I	Rise Time						130	270	ns
t _{d(off)}	Turn-Off	Delay Time						165	340	ns
t _f	Turn-Off	Fall Time			(Nc	ote 4, 5)		90	190	ns
Qg	Total Gate	e Charge		$V_{DS} = 480V, I_D = 16A$ $V_{GS} = 10V$				55	70	nC
Q _{gs}	Gate-Sou	irce Charge					10.5	13	nC	
Q _{gd}	Gate-Dra	in Charge			(Nc	ote 4, 5)		28		nC
Drain-Sour	ce Diode	Characteristics and	Maximum	Ratings		Į			•	
I _S	Maximum	n Continuous Drain-So	ource Diod	de Forward Current				16	Α	
I _{SM}	Maximum	Pulsed Drain-Source	e Diode Fo	prward Current				48	Α	
V _{SD}	Drain-Sou	urce Diode Forward V	oltage	$V_{GS} = 0V,$	I _S = 16A				1.4	V
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0V,$				435		ns
Q _{rr}	Reverse	Recovery Charge		$dI_F/dt = 10$	0A/μs (Note 4)		7.0		μC

NOTES:

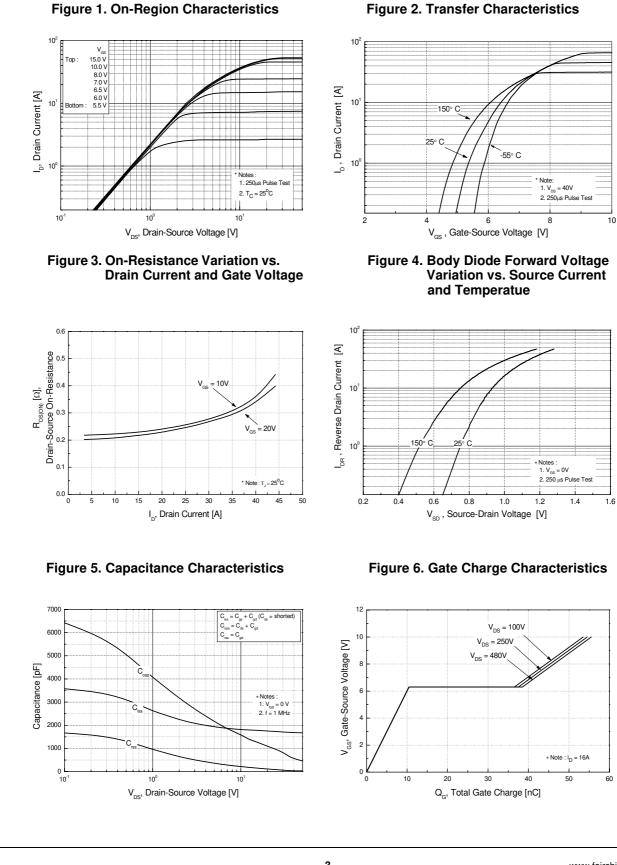
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 8A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. $I_{SD} \leq$ 16A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

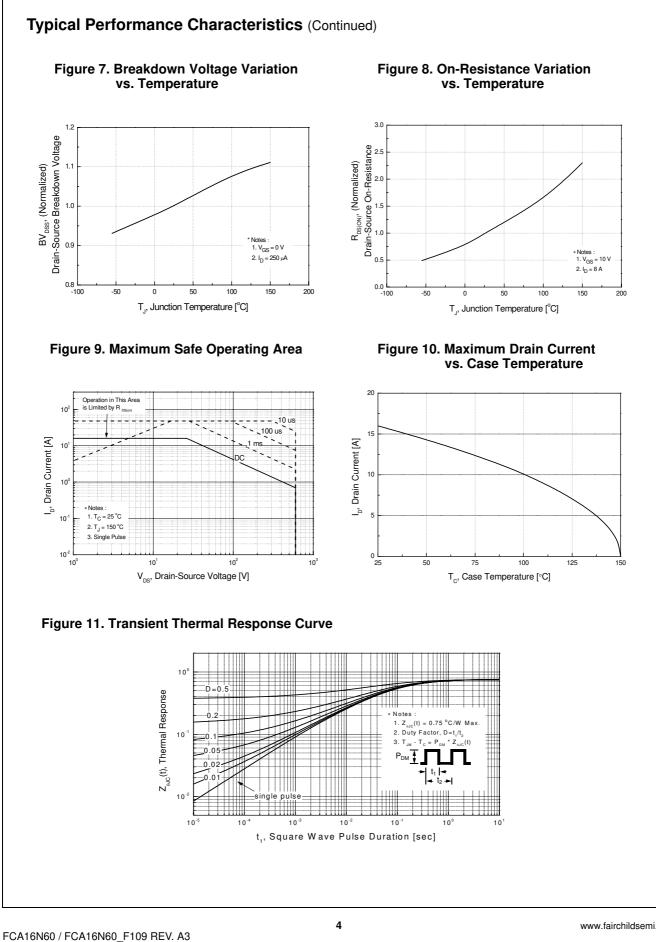
4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

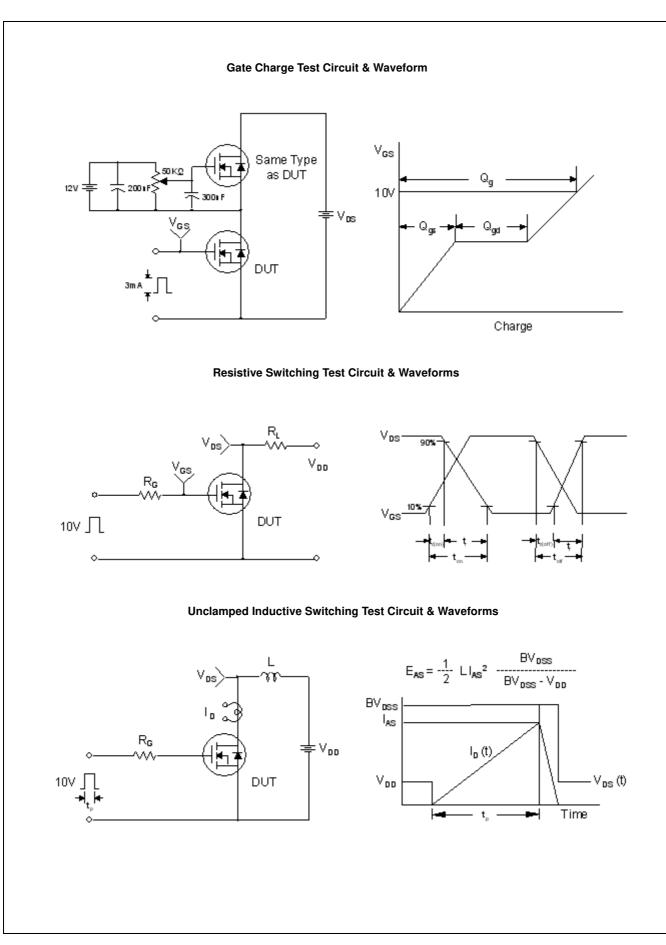
5. Essentially Independent of Operating Temperature Typical Characteristics

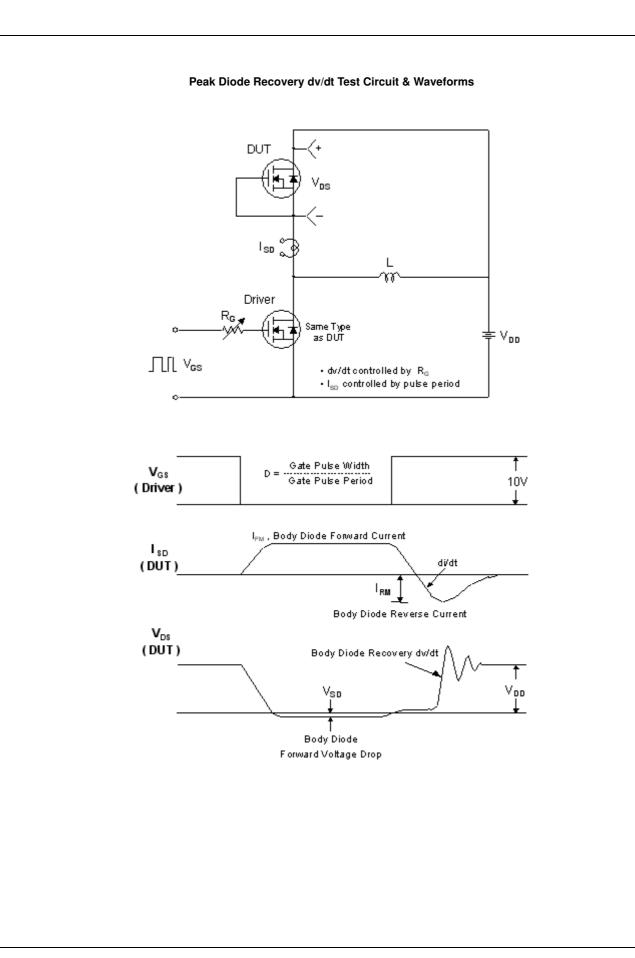


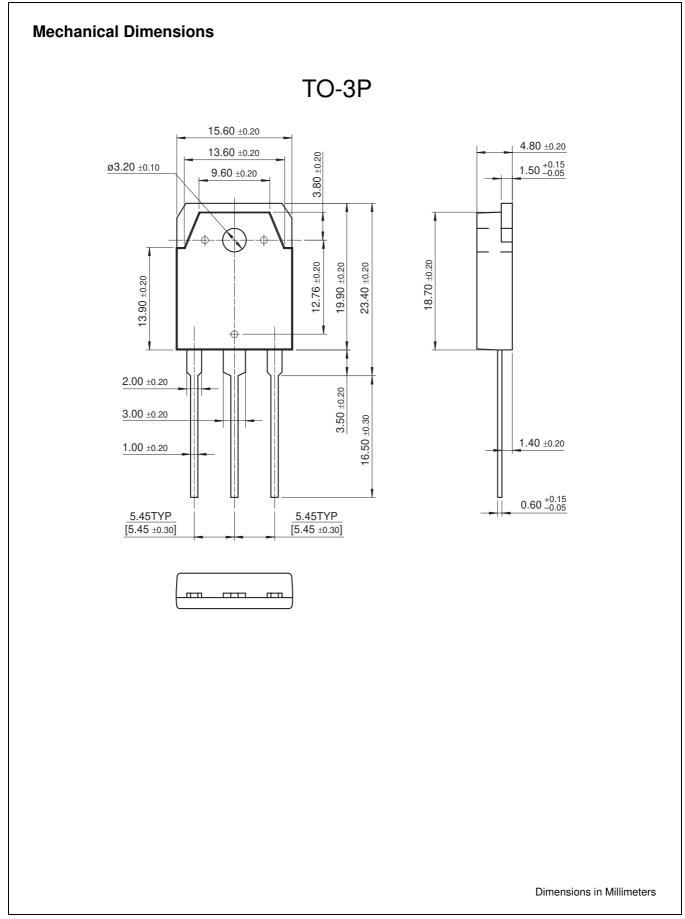
Typical Performance Characteristics

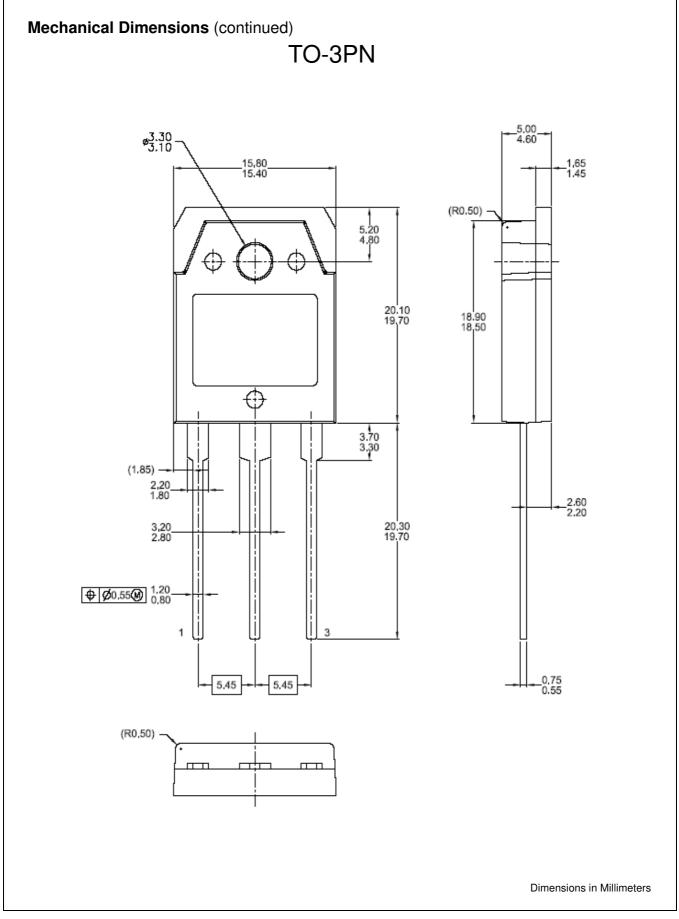
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